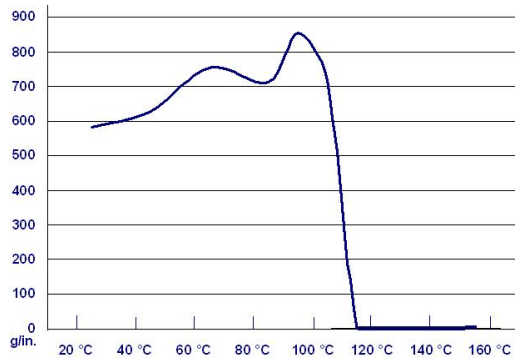
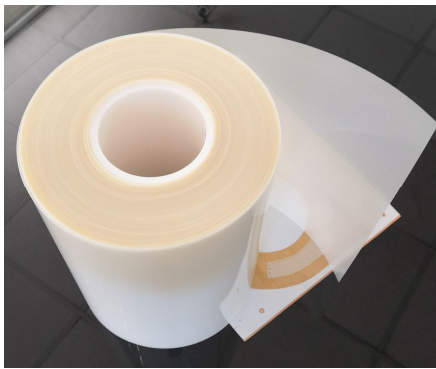


Double Sided Thermal Off Tape DTT1013



Pantech Double side Thermal Release tape DTT1013 is made of 100 μ PET, both sides coated with thermal release adhesive. It is most suitable for stacking, dicing and transfer of **Multi-Layer Ceramic Capacitor (MLCC)** and other chip devices, especially for those which can not be worked well through UV curable tapes.

It is RoHS and REACH free.

Characteristics:

Catalog No.	DTT1013
Substrate	PET
Thickness of substrate	0.100 mm
Thickness of adhesive	0.045 mm, both sides
Whiting starting temperature	110°C
Automatic thermal off temp.	130 °C × 60 seconds
Total thickness	0.190 mm
Tensile strength	>18 kg/in.
Elongation	100%
Adhesion to steel	700 ± 150 g/in.
Liner	0.050mm PET